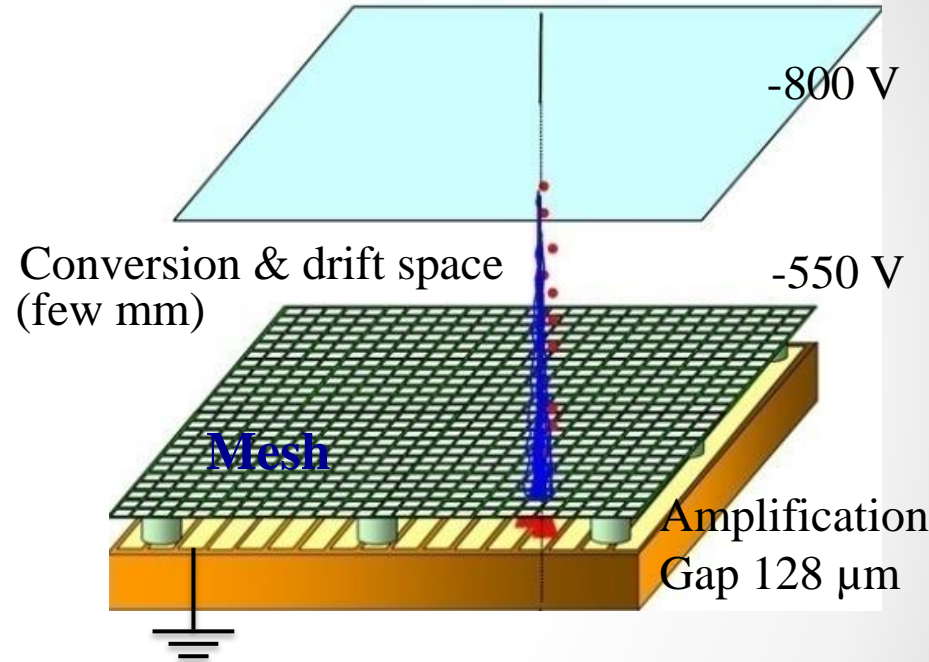


# Micro MESH Gaseous Detectors (MicroMegas)

RD51 Electronics school  
CERN 3 – 5 February 2014

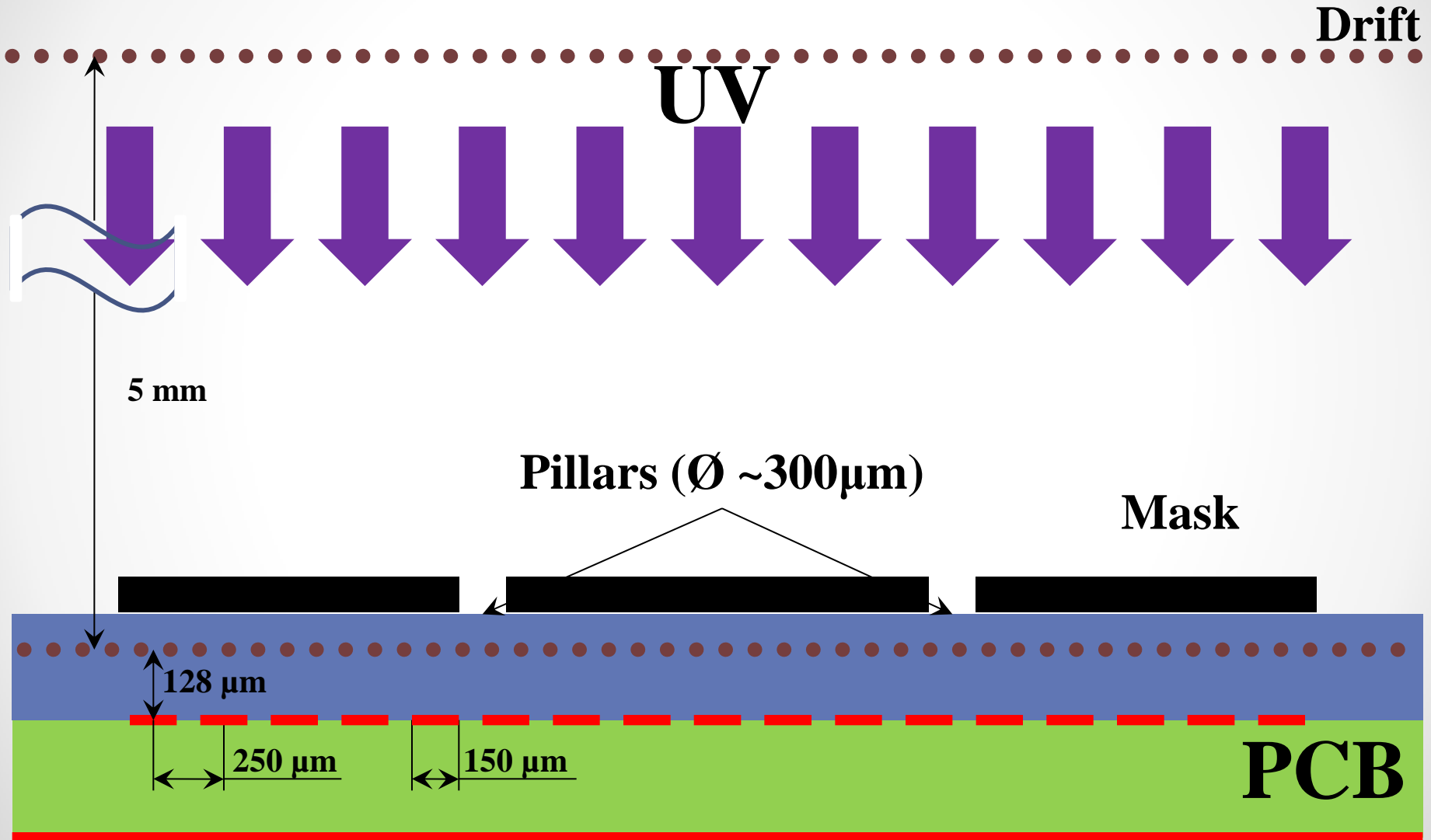
# What are Micromegas ?

- Micromegas are parallel-plate chambers where the amplification takes place in a thin gap, separated from the conversion region by a fine metallic mesh
- The thin amplification gap (short drift times and fast absorption of the positive ions) makes it particularly suited for high-rate applications

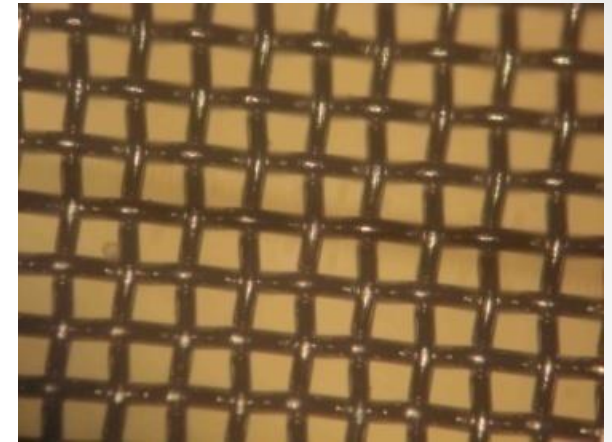
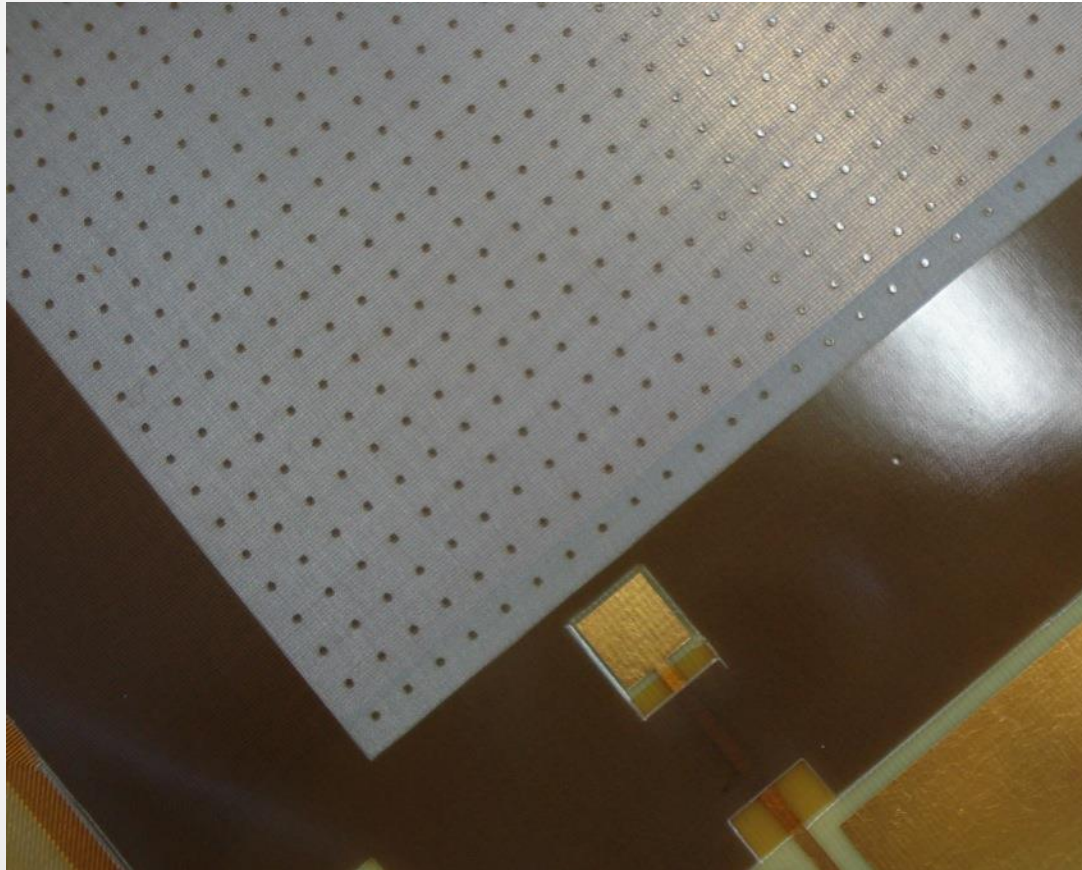


The principle of operation  
of a MicroMegas chamber

# The bulk MicroMegas technique



# Bulk MicroMegas structure

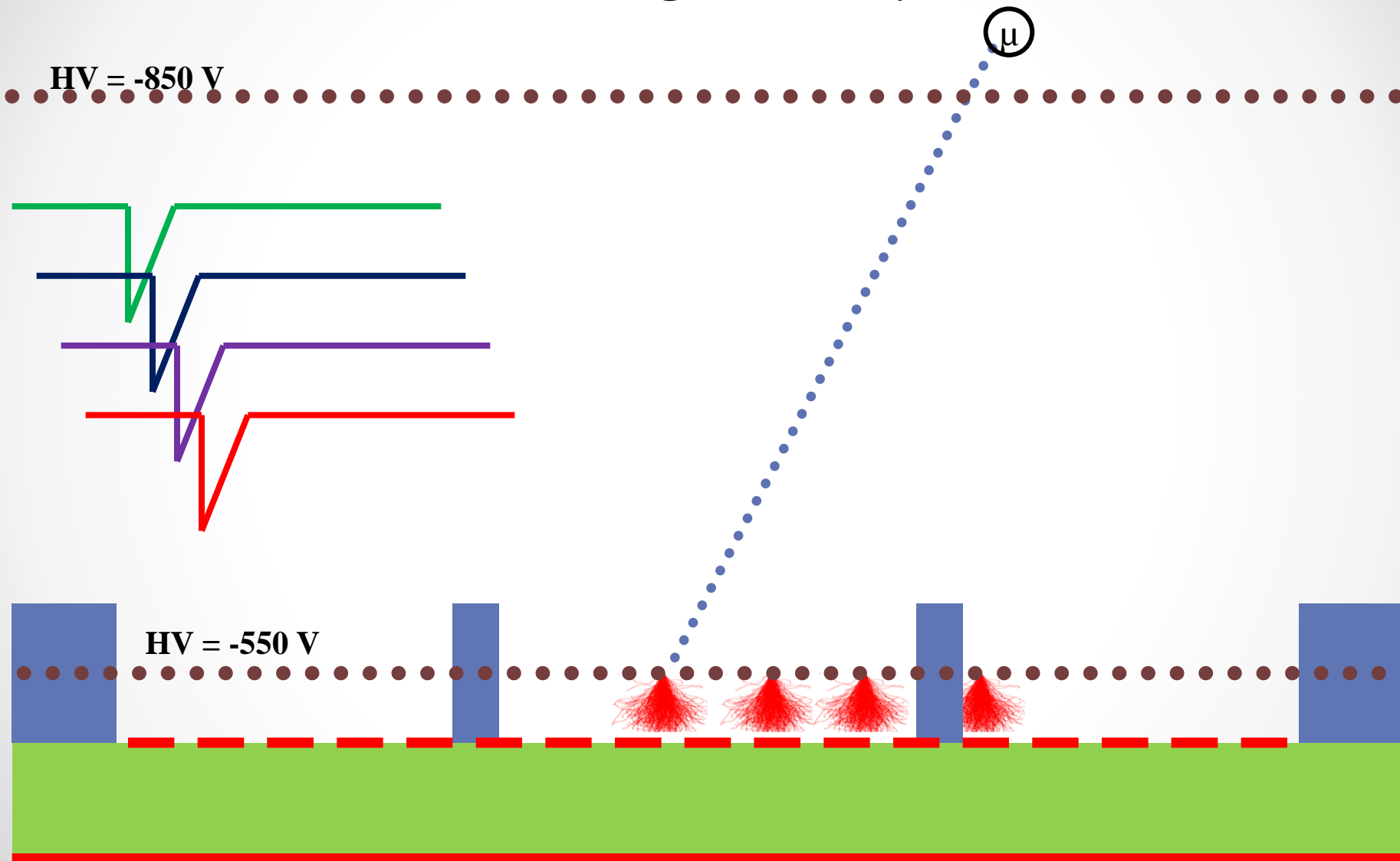


## Standard configuration

- Pillars every 5 (or 10) mm
- Pillar diameter  $\approx 350 \mu\text{m}$
- Dead area  $\approx 1.5$  (0.4)%
- Amplification gap  $128 \mu\text{m}$
- Mesh: 325 lines/inch

Pillar distance on photo: 2.5 mm

# MicroMegas as $\mu$ TPC



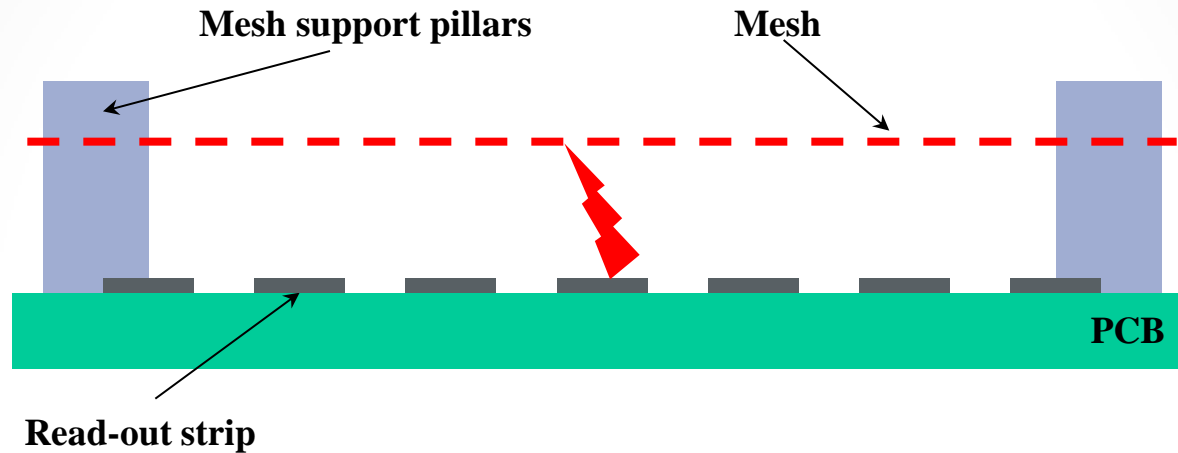
# Operating parameters

- Chambers are operating with an Ar:CO<sub>2</sub> (93:7) gas mixture (same gas as MDTs, safe and cheap, no flammable components)
- High Voltage (moderate HV requirements)
  - Mesh: -500 V (amplification field 40-50 kV/cm)
  - Drift-electrode: -800 V (~600 V/cm)
  - Currents in nA range

# Performance requirements

- Spatial resolution:  $\sim 60 \mu\text{m}$
- Angular resolution:  $\sim 0.3 \text{ mrad}$
- Good double track resolution
- Trigger capability
- Efficiency:  $> 98\%$

# Sparks in the chamber

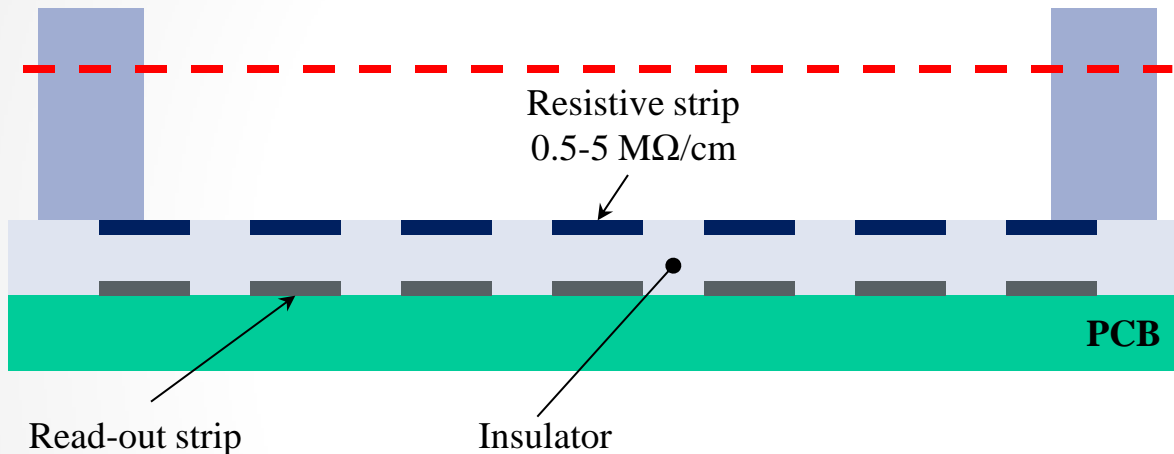


Sparks between mesh and readout strips may damage the detector and readout electronics and/or lead to large dead times as a result of HV breakdown



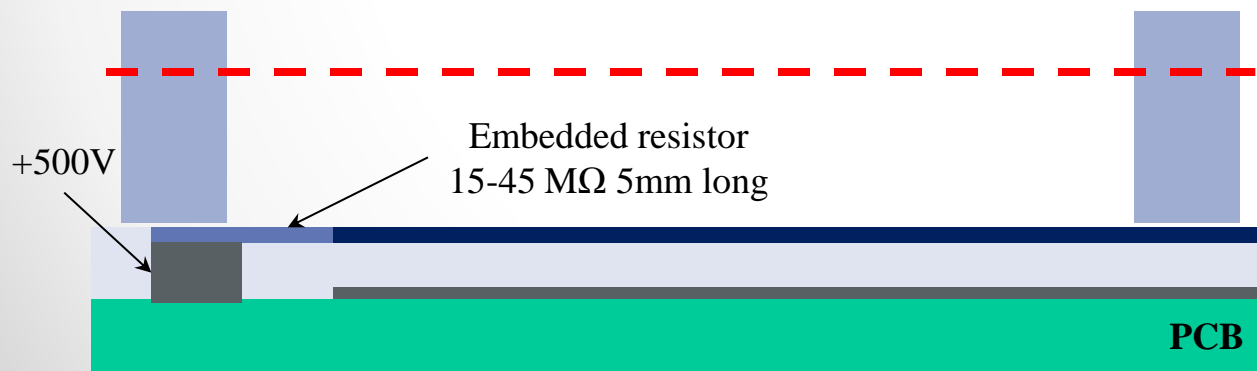
# Resistive MicroMegas chambers

To avoid spark effect the readout strips were covered with the 64  $\mu\text{m}$  thick insulator layer with resistive strips on top of it connected to the +HV via discharge resistor and mesh is connected to GND



Resistive characteristics of the chambers

CHAMBER	R11	R12	R13
HV resistor ( $\text{M}\Omega$ )	15	45	20
Resistance along strip ( $\text{M}\Omega/\text{cm}$ )	2	5	0.5

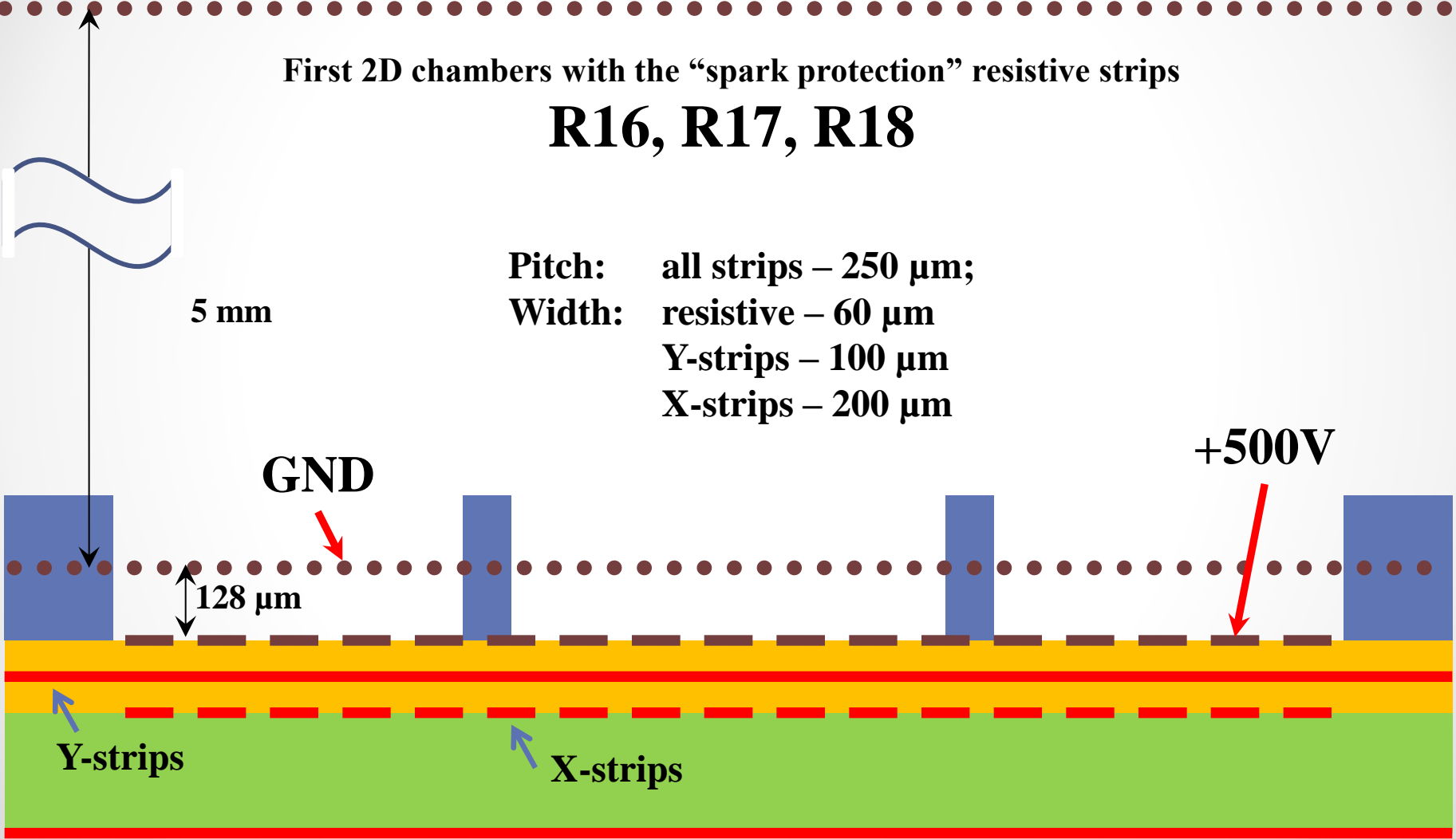


# Resistive MicroMegas chambers

**-300V**

First 2D chambers with the “spark protection” resistive strips

**R16, R17, R18**



5 mm

**Pitch:** all strips – 250 μm;  
**Width:** resistive – 60 μm  
Y-strips – 100 μm  
X-strips – 200 μm

**GND**

128 μm

**+500V**

Y-strips

X-strips

# Standard chamber vs resistive

## MicroMegas mesh currents and HV drop in neutron beam

Gas: Ar:CO<sub>2</sub> (85:15)

Neutron flux:  $\approx 10^6$  n/cm<sup>2</sup>/sec

### Standard MM:

Large currents

Large HV drops, recovery time O(1s)

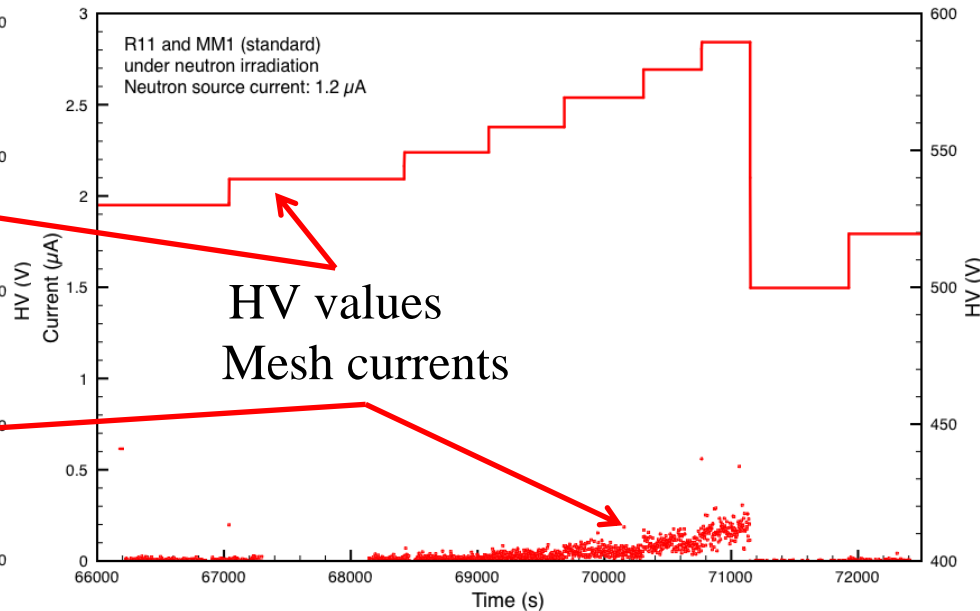
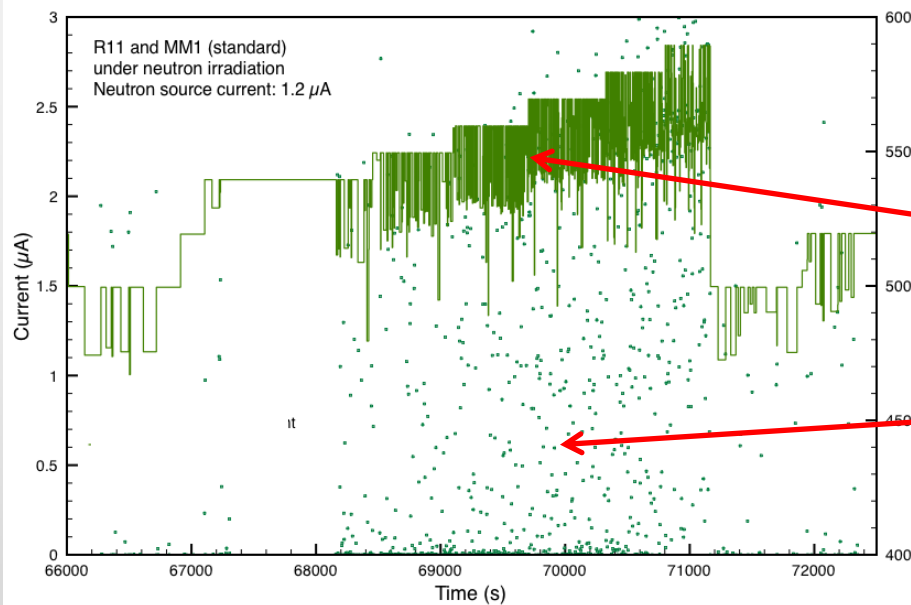
Chamber could not be operated stably

### R11:

Low currents

Despite discharges, but no HV drop

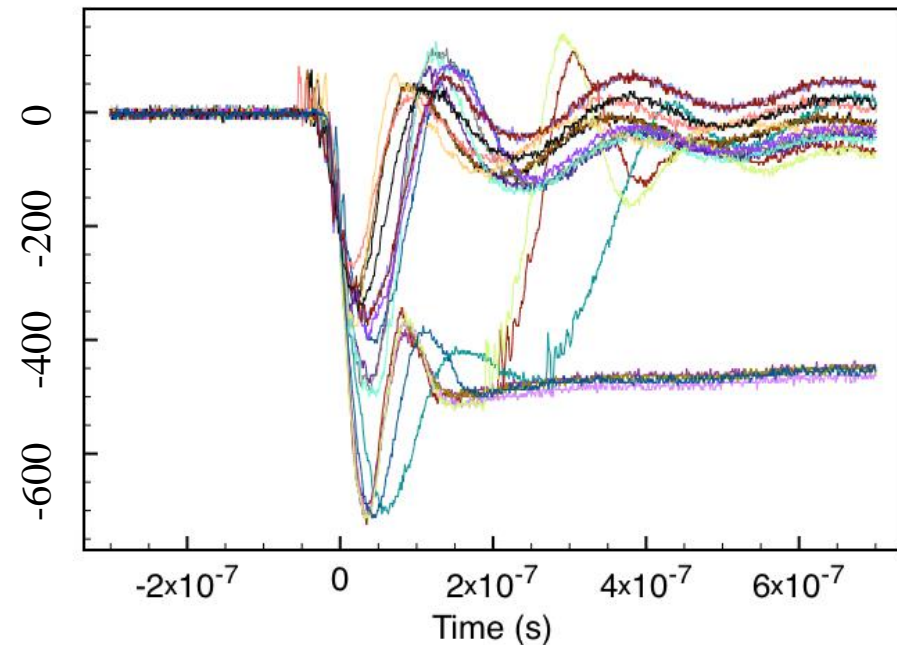
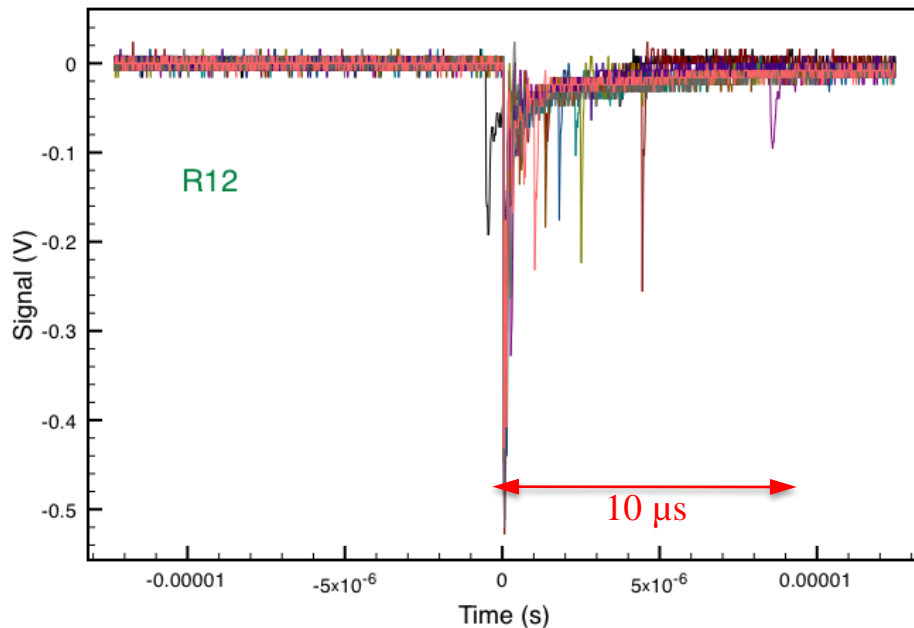
Chamber operated stably up to max HV



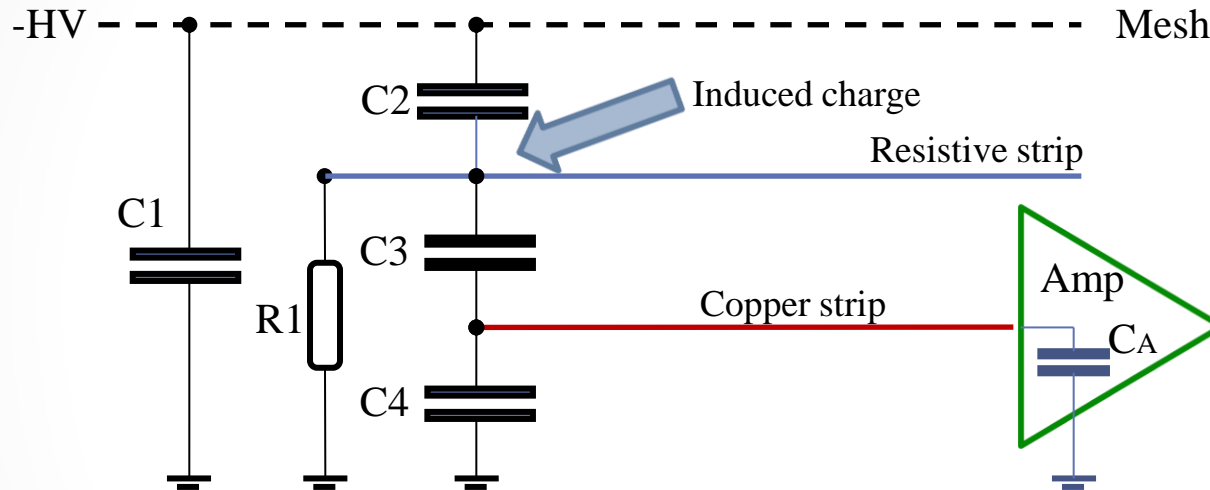
# Spark signals resistive vs standard

Sparks measured directly on readout strips through 50 Ohm  
Several spark signals plotted on top of each other to enhance the overall characteristics

R12 shows 2-3 order of magnitude less signal and shorter recovery time than standard MM



# Equivalent scheme of resistive MicroMegas chambers



- $C_1$  – capacitance Mesh to ground
- $C_2$  – capacitance R-strip to ground
- $C_3$  – capacitance R-strip to readout strip
- $C_4$  – capacitance readout strip to ground
- $C_A$  – input capacitance of preamplifier